

October 1987 Revised January 1999

MM74C175 Quad D-Type Flip-Flop

General Description

The MM74C175 consists of four positive-edge triggered D-type flip-flops implemented with monolithic CMOS technology. Both are true and complemented outputs from each flip-flop are externally available. All four flip-flops are controlled by a common clock and a common clear. Information at the D-type inputs meeting the set-up time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. The clearing operation, enabled by a negative pulse at Clear input, clears all four Q outputs to logical "0" and Q's to logical "1".

All inputs are protected from static discharge by diode clamps to \mbox{V}_{CC} and GND.

Features

■ Wide supply voltage range: 3V to 15V
■ Guaranteed noise margin: 1.0V
■ High noise immunity: 0.45 V_{CC} (typ.)

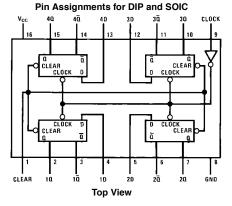
■ Low power TTL compatibility: Fan out of 2 driving 74L

Ordering Code:

Order Number	Package Number	Package Description				
MM74C175M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow				
MM74C175N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide				

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Connection Diagram



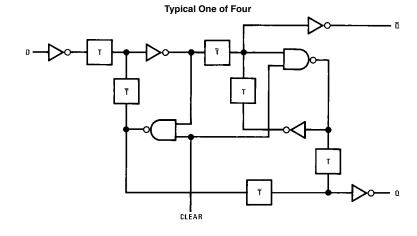
Truth Table

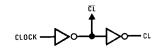
Each Flip-Flop

Inputs			Outputs		
Clear	Clock	D	Q	Q	
L	Х	Х	L	Н	
Н	1	Н	Н	L	
Н	1	L	L	Н	
Н	Н	Х	NC	NC	
Н	L	Х	NC	NC	

- H = HIGH Level
- L = LOW Level
- X = Irrelevant
- ↑ = Transition from LOW-to-HIGH level
- NC = No Change

Block Diagrams









Absolute Maximum Ratings(Note 1)

Voltage at Any Pin -0.3V to V_{CC} +0.3V Operating Temperature Range -40°C to +85°C Storage Temperature Range -65°C to +150°C

Power Dissipation (P_D)

 $\begin{array}{ccc} \text{Dual-In-Line} & 700 \text{ mW} \\ \text{Small Outline} & 500 \text{ mW} \\ \text{Operating V}_{\text{CC}} \text{ Range} & 3\text{V to 15V} \\ \end{array}$

 $\begin{array}{lll} \mbox{Absolute Maximum V}_{\mbox{CC}} & \mbox{18V} \\ \mbox{Lead Temperature} & \\ \mbox{(Soldering, 10 seconds)} & \mbox{260}^{\circ}\mbox{C} \end{array}$

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The Electrical Characteristics table provides conditions for actual device operation.

DC Electrical Characteristics

Min/Max limits apply across temperature range unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Units
CMOS TO	CMOS	- I	l			
V _{IN(1)}	Logical "1" Input Voltage	V _{CC} = 5V	3.5			V
		V _{CC} = 10V	8.0			V
V _{IN(0)}	Logical "0" Input Voltage	V _{CC} = 5V			1.5	V
		V _{CC} = 10V			2.0	V
V _{OUT(1)}	Logical "1" Output Voltage	$V_{CC} = 5V$, $I_{O} = -10 \mu A$	4.5			V
		$V_{CC} = 10V$, $I_{O} = -10 \mu A$	9.0			V
V _{OUT(0)}	Logical "0" Output Voltage	$V_{CC} = 5V$, $I_{O} = 10 \mu A$			0.5	V
		$V_{CC} = 10V, I_{O} = 10 \mu A$			1.0	V
I _{IN(1)}	Logical "1" Input Current	V _{CC} = 15V, V _{IN} = 15V		0.005	1.0	μΑ
I _{IN(0)}	Logical "0" Input Current	V _{CC} = 15V, V _{IN} = 0V	-1.0	-0.005		μΑ
I _{CC}	Supply Current	V _{CC} = 15V		0.05	300	μΑ
CMOS/LP	ITL INTERFACE	•		U	U	
V _{IN(1)}	Logical "1" Input Voltage	74C, V _{CC} = 4.75V	V _{CC} - 1.5			V
V _{IN(0)}	Logical "0" Input Voltage	74C, V _{CC} = 4.75V			0.8	V
V _{OUT(1)}	Logical "1" Output Voltage	74C, $V_{CC} = 4.75V$, $I_{O} = -360 \mu A$	2.4			V
V _{OUT(0)}	Logical "0" Output Voltage	74C, V _{CC} = 4.75V, I _O = 360 μA			0.4	V
	ORIVE (See Family Characteristics	Data Sheet) (Short Circuit Current)				
I _{SOURCE}	Output Source Current	V _{CC} = 5V, T _A = 25°C,	-1.75	-3.3		mA
	(P-Channel)	$V_{OUT} = 0V$				
I _{SOURCE}	Output Source Current	V _{CC} = 10V, T _A = 25°C,	-8.0	-15		mA
	(P-Channel)	V _{OUT} = 0V				
I _{SINK}	Output Sink Current	V _{CC} = 5V, T _A = 25°C,	1.75	3.6		mA
	(N-Channel)	$V_{OUT} = V_{CC}$				
I _{SINK}	Output Sink Current	V _{CC} = 10V, T _A = 25°C,	8.0	16		mA
	(N-Channel)	$V_{OUT} = V_{CC}$				

AC Electrical Characteristics (Note 2) $T_A = 25^{\circ}C$, $C_L = 50$ pF, unless otherwise noted

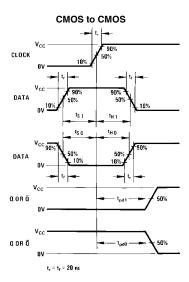
Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{pd}	Propagation Delay Time to	V _{CC} = 5V		190	300	ns
	a Logical "0" or Logical "1" from	V _{CC} = 10V		75	110	ns
	Clock to Q or Q					
t _{pd}	Propagation Delay Time to a	V _{CC} = 5V		180	300	ns
	Logical "0" from Clear to Q	V _{CC} = 10V		70	110	ns
t _{pd}	Propagation Delay Time to a	V _{CC} = 5V		230	400	ns
	Logical "1" from Clear to Q	V _{CC} = 10V		90	150	ns
t _S	Time Prior to Clock Pulse that	V _{CC} = 5V	100	45		ns
	Data Must be Present	V _{CC} = 10V	40	16		ns
t _H	Time After Clock Pulse that	V _{CC} = 5V	0	-11		ns
	Data Must be Held	V _{CC} = 10V	0	-4		ns
t _W	Minimum Clock Pulse Width	V _{CC} = 5.0V		130	250	ns
		V _{CC} = 10V		45	100	ns
t _W	Minimum Clear Pulse Width	V _{CC} = 5.0V		120	250	ns
		V _{CC} = 10V		45	100	ns
t _r	Maximum Clock Rise Time	V _{CC} = 5V	15	450		μS
		V _{CC} = 10V	5.0	125		μS
t _f	Maximum Clock Fall Time	V _{CC} = 5V	15	50		μS
		V _{CC} = 10V	5.0	50		μS
f _{MAX}	Maximum Clock Frequency	V _{CC} = 5V	2.0	3.5		MHz
		V _{CC} = 10V	5.0	10		MHz
C _{IN}	Input Capacitance	Clear Input (Note 3)		10		pF
		Any Other Input		5.0		pF
C _{PD}	Power Dissipation Capacitance	Per Package (Note 4)		130		pF

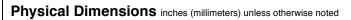
Note 2: AC Parameters are guaranteed by DC correlated testing.

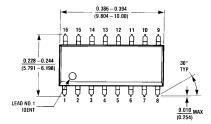
Note 3: Capacitance is guaranteed by periodic testing.

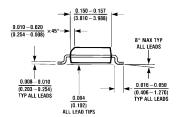
Note 4: C_{PD} determines the no load AC power consumption of any CMOS device. For complete explanation see Family Characteristics Application Note

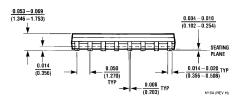
Switching Time Waveforms





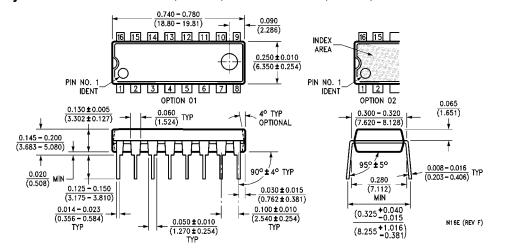






16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M16A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N16E

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